

## Statement of Compliance

## **Requested Part**

16 December 2009	1-794106-0		( Part 1 of 1)
20P MINI UMNL R/A HDR ASSY			
S	tatus:	Active	
EU RoHS/ELV	Code:	Always EU RoHS/ELV Compliant	
Solder Process Capability	Code:	Wave solder capable to 265°C	
China F	RoHS:	No Restricted Materials	Above Threshold
Exemp	otions:	No Substance>Threshold	l
REACH Oct 2008 SvHC Compli	ance:	Contains no REACH Octo	ober 2008 SvHC(s)
REACH Dec 2009 SvHC Compli	ance:	Not reviewed for REACH SvHC(s)	December 2009
Halogen Co	ntent:	Not reviewed for halogen	content

DRL

David R. Bender Director, Product Compliance

The part numbers that Tyco Electronics has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as Tyco Electronics cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.